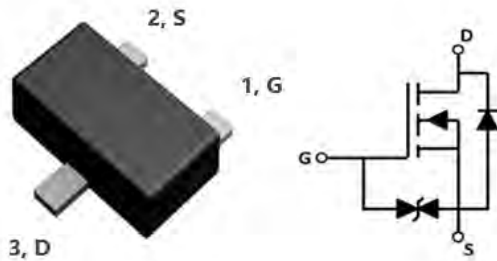


## N-Channel Enhancement Mode Field Effect Transistor



**SOT-723**

### Product Summary

- $V_{DS}$  20V
- $I_D$  0.75A
- $R_{DS(ON)}$ ( at  $V_{GS}=4.5V$ ) <250 mohm
- $R_{DS(ON)}$ ( at  $V_{GS}=2.5V$ ) <350 mohm
- ESD Protected Up to 3.0KV (HBM)

### General Description

- Trench Power LV MOSFET technology
- High Power and current handing capability
- Moisture Sensitivity: Level 3 per J-STD-020

### Applications

- Load/Power Switching
- Interfacing Switching
- Logic Level Shift

### ■ Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		$V_{DS}$	20	V
Gate-source Voltage		$V_{GS}$	$\pm 12$	V
Drain Current	$T_A=25^\circ\text{C}$ @ Steady State	$I_D$	0.75	A
	$T_A=70^\circ\text{C}$ @ Steady State		0.6	
Pulsed Drain Current <sup>A</sup>		$I_{DM}$	3.0	A
Total Power Dissipation @ $T_A=25^\circ\text{C}$		$P_D$	0.15	W
Thermal Resistance Junction-to-Ambient @ Steady State		$R_{\theta JA}$	833	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~+150	$^\circ\text{C}$

### ■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
LM3134KT		KF	8000			7" reel

## ■ Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

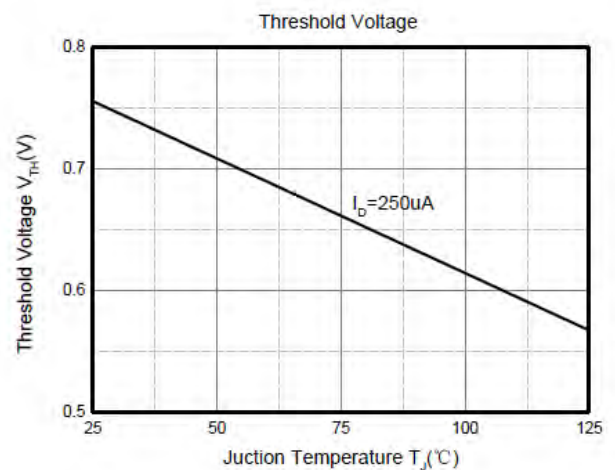
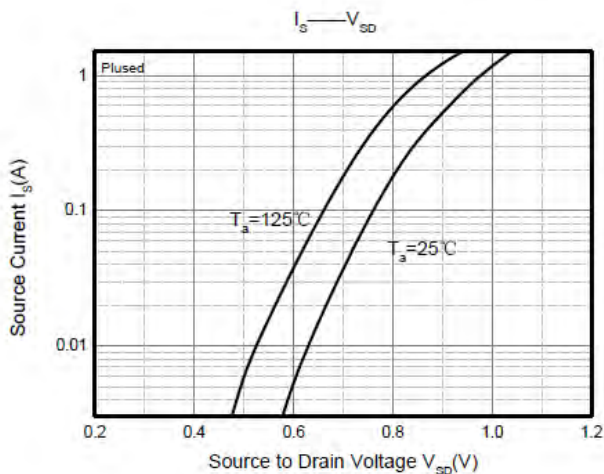
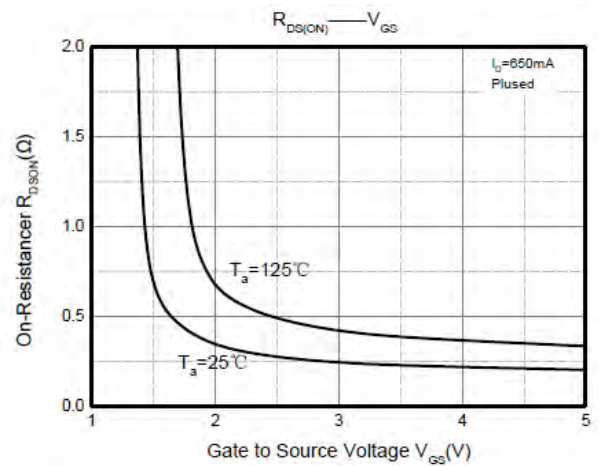
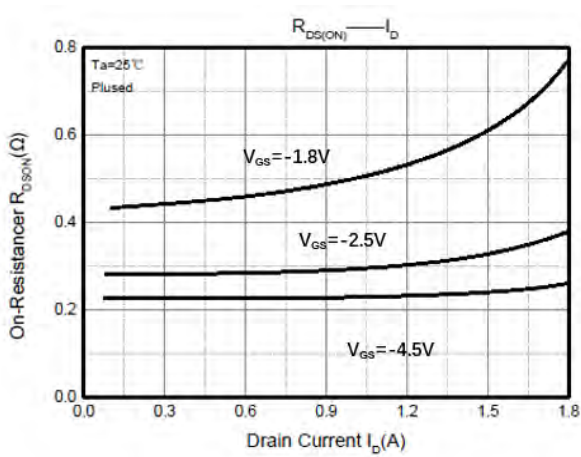
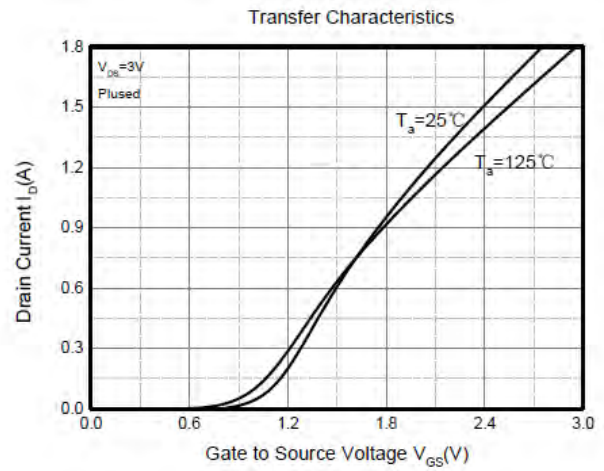
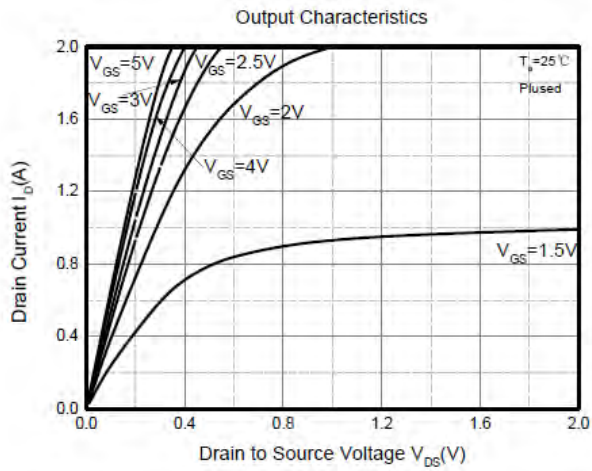
Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	20			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±10V, V <sub>DS</sub> =0V		2.5	±10	μA
		V <sub>GS</sub> = ±8V, V <sub>DS</sub> =0V		500	±2000	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA	0.35	0.75	1.1	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> =0.65A		130	250	mΩ
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> =0.3A		180	350	
Diode Forward Voltage <sup>C</sup>	V <sub>SD</sub>	I <sub>S</sub> =0.5A, V <sub>GS</sub> =0V			1.2	V
Maximum Body-Diode Continuous Current	I <sub>S</sub>				0.75	A
<b>Dynamic Parameters <sup>B</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f=1MHZ			110	pF
Output Capacitance	C <sub>oss</sub>				18	
Reverse Transfer Capacitance	C <sub>rss</sub>				15	
<b>Switching Parameters <sup>B</sup></b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, I <sub>D</sub> =0.5A		1.1		nC
Gate Source Charge	Q <sub>gs</sub>			0.19		
Gate Drain Charge	Q <sub>gd</sub>			0.27		
Turn-on Delay Time	t <sub>D(on)</sub>	V <sub>GS</sub> =4.5V, V <sub>DD</sub> =10V, R <sub>G</sub> =10Ω, I <sub>D</sub> =0.5A		6.7		ns
Turn-on Rise Time	t <sub>r</sub>			4.8		
Turn-off Delay Time	t <sub>D(off)</sub>			17.3		
Turn-off Fall Time	t <sub>f</sub>			7.4		

A. Repetitive Rating: Pulse width limited by maximum junction temperature.

B. These parameters have no way to verify.

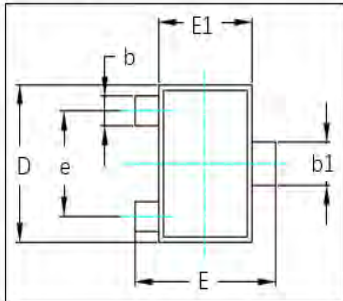
C. Pulse Test: Pulse Width ≤ 300us, Duty Cycle ≤ 0.5%.

## ■ Typical Performance Characteristics

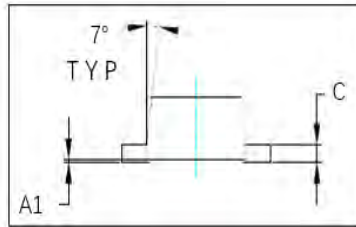


## ■SOT-723 Package information

Top view

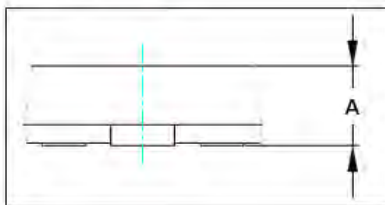


Side view



SYMBOL	DIMENSIONS IN MILLIMETER	
	MIN	MAX
A	0.430	0.500
A1	0.000	0.050
b	0.170	0.270
b1	0.270	0.370
C	0.080	0.150
D	1.150	1.250
E	1.250	1.500
E1	0.750	0.850
e	0.800 TYP.	
Θ	0°	7°

Front view



Soldering Pattern

